Compliant with SD Memory Card Specification 3.0 and backwards-compatible with 2.0, 1.1, and 1.01

silicon-power.com/web/gb/product-SDT320



Specifications

- Flash Technology
- MLC / 3D TLC
- Capacity
- 8GB ~ 16GB
- Interface
- SD 3.0 / UHS-I
- Storage Temperature
- $-40^{\circ}\text{C} \sim 85^{\circ}\text{C}$

- Seq. Performance Read (max.)
- 81 MB/s
- Seq. Performance Write (max.)
- 46 MB/s
- Power Requirement
- DC 3.3V
- Power Consumption(max.)
- 58 mA
- Power Consumption (idle)
- 90 uA
- Dimension (mm)
- 15.0 x 11.0 x 1.0
- MTBF (est)
- \(\perp 2,000,000\) hrs
- Operating Temp. (Standard)
- SP***GISDT325NE0
- Operating Humidity
- 10% ~ 95% (30°C Max. Wet Bulb Temp)
- Vibration
- 15G, 10 ~ 2000Hz
- Drop
- 150cm
- Shock
- 1,500G@0.5ms
- Torque
- 0.15Nm
- Bending
- 10N
- Duration (cycles)
- 10000
- Warranty
- 3 years and within guranteed TBW

Features

- Compliant with SD Memory Card Specification 3.0 and backwards-compatible with 2.0, 1.1, and 1.01
- High endurance suitable for 24/7 continuous video recording
- Steady performance design to ensure all frames are recorded
- Supports SP Toolbox SMART Health Monitoring System software (optional)

SDT320 MLC / 3D TLC

Form Factor	NAND	Capacity	Temp.	P/N
microSD	MLC	8GB	-25~85°C	SP008GISDT325NE0
microSD	MLC	16GB	-25~85°C	SP016GISDT325NE0